# Environm-9500 **Nitrosave** Oxygen Control System Stion Analysing

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**Analysing** 

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The Nitrosave control system combined with a state of the art trace and percent oxygen measurement technology offers cost of ownership with pay back times in Nitrogen savings within a few years.



### **Features & Benefits**

- Save on Nitrogen usage and rework costs.
- Improve process control and product quality.
- Automatically detects a halt in production and reduces N2 flow for even greater savings.
- Extremely fast response time even after high oxygen exursions mean quicker process optimisation.

- Nitrosave Viewer PC software makes set up quick and easy.
- RS232 communications output for data logging can document the whole process.
- Small footprint allows OEM manufacturer to install inside their machine.

**Conforms to European Directives:** 

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## Save Nitrogen and

#### **Nitrosave**

Nitrosave consists of the oxygen monitor/control unit and a proportional or other control valve which is fitted into the nitrogen supply line to the machine.

Nitrosave monitors the residual oxygen in the system under control using Systech's latest cell technology. The oxygen measurement is then used together with a fuzzy logic control algorithm and user defined setpoints for desired oxygen level, to automatically control the opening of the valve, which regulates the flow of nitrogen into the machine.

This ensures enough nitrogen to comfortably maintain the desired oxygen level is fed into the machine but eliminates the waste seen with fixed flow nitrogen systems.

Installation of the Nitrosave is very simple and it can be retrofitted to almost all types of machines.

Once in place setting up the control system is straight forward and can be done when the machine is in production. It is always possible to revert to manual control and the system will automatically select maximum flow in the event of a fault.

Nitrogen is used in soldering and other controlled atmosphere machines to remove oxygen which results in better production quality. However nitrogen can be expensive.

Systech's long expertise in the field of Gas Analysis led to the development, in partnership with major soldering machine manufacturers, of the Nitrosave, designed to reduce the nitrogen consumption of your machine.



### **Control Valves**

Various sizes, types, flow rates and connections to suit every machine. Allows control of main  $N_2$  flow or specific zones in the machine.

## **Outputs & Alarm**

For data logging, chart recorders and remote monitoring

- RS232
- 4-20mA/0-10v
- 2 high / low alarms
- Fault alarm

### **Doping Systems**

Mass Flow controlled, or other, doping for control at high oxygen levels (500ppm+). Ideal when soldering BGA components.

## **Improve Process Control**

This technology is easily transferred to other inerted machines. Whether you have a small wave machine or large reflow system the savings with Nitrosave are considerable. With nitrogen reductions of 25-70%, the payback time for the system is very short, with the added benefits of improvements in process control and full traceability.



## **Operator Interface**

- User friendly menu
- Setpoints & alarm settings
- Control configuration
- Read only mode

#### **Nitrosave Viewer**

Datalogging is simple with the provided Nitrosave Viewer program. This allows a log of a number of machine parameters (including oxygen level and valve opening) to be made. The data is stored as a text file which can be easily manipulated and displayed graphically using spreadsheet programs.

## **Photoswitch PCB Detector**

Automatically detects a halt in production and reduces N<sub>2</sub> flow for even greater savings.

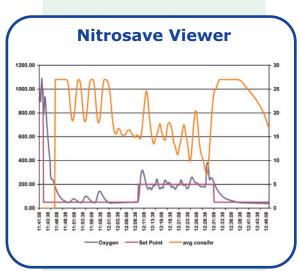
## **Principle of Operation**

Nitrosave uses Systech's patented RACE sensor\*. A unique electrochemical cell which responds in seconds even to large changes in oxygen levels and is unaffected by solvent vapours or hydrocarbons making it ideal for use in systems where high oxygen events are common.

Development of the RACE<sup>TM</sup> cell allows oxygen measurements to be made across the full range normally found in a soldering oven, without delays due to the purging of the measurement system or sample lines. The high speed of the cell ensures a very rapid start up response and accurate monitoring of changes in the machine atmosphere during production.

The RACE™ sensor is maintenance free and only requires infrequent calibration. RACE™ sensors carry a 3 year limited guarantee.

\* UK Patent no. 2324870 USA Patent no. 5929318



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## Systech 9500 - Nitrosave Oxygen Control System



Bench/Panel Mount 190H x 237W x 410D (mm) 8.4 kg



IP66/NEMA 4X Wall Mount/Weatherproof 460H x 380W x 160D (mm) 15.5kg



Rack Mount 4U - 19 inch Houses 1 or 2 Analysers 178H x 484W x 410D (mm) 9.7kg (single unit)

## **Technical Specifications**

Sensor Type Dependent on Application

0.01ppm - 100% O<sub>2</sub> Autoranging Ranges Accuracy Dependent on measurement method

Measuring Cell Type Electrochemical or Zirconia solid state, dependent on application.

Communications RS232/485

Alarms 2 programmable changeover contacts, rated 240V 3A

1 fault alarm, changeover contact, rated 240V 3A

**Analogue Outputs** 2 scaleable 4-20mA, 0-10V, 0-100mV, all isolated

1 for control valve.

**Operating Conditions** 

Sample Connections 1/8 inch O/D compression **Ambient Temperature** 5 to 50°C (23° to 122°F)

100 -300 ml/min (internal pump) Sample Gas Flow Rate Power 230/110 VAC selectable, 80VA

**Options** 

**Product Sensor** Detects halt in production, software can engage new set points. Valve Options Flow rates dependent on oven. Contact Systech for more information.

MFC Doping Option Air injection systems.

Systech Instruments have over 25 years experience of providing analysis solutions for a wide range of industries. From our manufacturing plant in the UK we produce gas analysers for industrial process industries, headspace analysers for monitoring gas flushing of food products, and our range of permeation analysers.



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